# <u>SHOUDING</u>

#### 1MHz, 2A Step-Up Current Mode PWM Converter

#### **General Description**

The SD6271 is a current mode boost DC-DC converter. Its PWM circuitry with built-in  $0.25\Omega$  power MOSFET make this regulator highly power efficient. The internal compensation network also minimizes as much as 6 external component counts. The non-inverting input of error amplifier connects to a 0.6V precision reference voltage and internal soft-start function can reduce the inrush current.

The SD6271 is available in the SOT23-6L package and provides space-saving PCB for the application fields.

#### **Features**

- Adjustable Output up to 24V
- Internal Fixed PWM frequency: 1.0MHz
- Precision Feedback Reference Voltage: 0.6V (±2%)
- > Internal 0.25Ω, 2A, 26V Power MOSFET
- ➢ Shutdown Current: 0.1µA
- > Over Voltage Protection
- Over Temperature Protection
- > Adjustable Over Current Protection: 0.5A ~ 2.5A
- Package: SOT23-6L

#### **Applications**

- > Chargers
- LCD Displays
- > Digital Cameras
- > Handheld Devices
- Portable Products

## **Typical Application Circuit**



# **Function Block Diagram**



# **Pin Descriptions**



Name	No.	1/0	Description	
LX	1	0	Power Switch Output	
GND	2	Р	IC Ground	
FB	3	Ι	Error Amplifier Inverting Input	
EN	4	Ι	Enable Control (Active High)	
V <sub>CC</sub>	5	Р	IC Power Supply	
OC	6	I	Adjustable Current Limit (Floating Available)	

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# Marking Information SOT23-6L



Lot Number: Wafer lot number's last two digits

For Example: 132366TB → 86

Year: Production year's last digit

Part Number Code: Part number identification code for this product. It should be always "AL".

### **Ordering Information**

Part Number	Code	<b>Operating Temperature</b>	Package	MOQ	Description
SD6271LR-G1	AL	-40°C ~ 85°C	SOT23-6L	3000EA	Tape & Reel

#### **Absolute Maximum Ratings**

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Supply Voltage	V <sub>cc</sub>		0		6	V
OVP Voltage	V <sub>OVP</sub>		0		28	V
LX Voltage	V <sub>LX</sub>		0		28	V
EN,FB Voltage			0		6	V
Power Dissipation	PD	SOT23-6L @T <sub>A</sub> =25°C			455	mW
Thermal Resistance (Note1)	θ <sub>JA</sub>	SOT23-6L			+220	°C / W
Junction Temperature	TJ				+150	°C
Operating Temperature	T <sub>OP</sub>		-40		+85	°C
Storage Temperature	T <sub>ST</sub>		-65		+150	°C
Lead Temperature		(soldering, 10 sec)			+260	°C

#### Note1:

 $\theta_{JA}$  is measured in the natural convection at  $T_A=25^{\circ}C$  on a low effective thermal conductivity test board of JEDEC 51-3 thermal measurement standard.



## IR Re-flow Soldering Curve

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### **Recommended Operating Conditions**

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Supply Voltage	Vin		2.6		5.5	V
Operating Temperature Range	T <sub>A</sub>	Ambient Temperature	-40		+85	°C

## DC Electrical Characteristics (V<sub>CC</sub>=3.3V, T<sub>A</sub>=25°C, unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
System Supply Input							
Input Supply Range	Vcc		2.6		5.5	V	
Under Voltage Lockout	V <sub>UVLO</sub>			2.2		V	
UVLO Hysteresis				0.1		V	
Quiescent Current	Icc	V <sub>FB</sub> =0.66V, No switching		0.16		mA	
Average Supply Current	I <sub>CC</sub>	V <sub>FB</sub> =0.55V, Switching		2.84		mA	
Shutdown Supply Current	I <sub>CC</sub>	V <sub>EN</sub> =GND		0.1		μA	
Oscillator							
Operation Frequency	Fosc	V <sub>FB</sub> =1.0V	0.8	1.0	1.2	MHz	
Frequency Change with Voltage	$\triangle f / \triangle V$	V <sub>CC</sub> =2.7V to 5.5V		5		%	
Maximum Duty Cycle	T <sub>DUTY</sub>			90		%	
Reference Voltage							
Feedback Voltage	$V_{REF}$		0.588	0.6	0.612	V	
Line Regulation		V <sub>CC</sub> =2.7V ~ 5.5V		0.05		% / V	
Enable Control	•		·				
Enable Voltage	V <sub>EN</sub>		0.96			V	
Shutdown Voltage	V <sub>EN</sub>				0.6	V	
MOSFET							
On Resistance of Driver	R <sub>DS (ON)</sub>	I <sub>LX</sub> =2A		0.25		Ω	
Protection							
OVP Threshold Voltage	VOVP			27		V	
OVP Sink Current	I <sub>SINK</sub>			5		μA	
OCP Current	I <sub>OCP</sub>		2		2.6	Α	
Adjustable OCP Current	I <sub>OCP</sub>	With External Resistor: 10k~100k	0.5		2.6	A	
OTP Temperature	T <sub>OTP</sub>			+150		°C	

### **Function Description**

#### Operation

The SD6271 is a current mode boost converter. The constant switching frequency is 1MHz and operates with pulse width modulation (PWM). Build-in 26V / 2A MOSFET provides a high output voltage. The control loop architecture is peak current mode control; therefore slope compensation circuit is added to the current signal to allow stable operation for duty cycles larger than 50%.

#### Soft Start Function

Soft start circuitry is integrated into SD6271 to avoid inrush current during power on. After the IC is enabled, the output of error amplifier is clamped by the internal soft-start function, which causes PWM pulse width increasing slowly and thus reducing input surge current.

#### **Current Limit Program**

A resistor between OC and GND pin programs peak switch current. The resistor value should be between 10k and 100k. The current limit will be set from 2.5A to 0.5A. Keep traces at this pin as short as possible. Do not put capacitance at this pin. To set the over current trip point according to the following equation:

$$I_{OCP} = \frac{48000}{R3}$$

#### **Over Voltage Protection (OVP)**

In some condition, the resistive divider may be unconnected, which will cause PWM signal to operate with maximum duty cycle and power switch voltage is boosted higher and higher. The power MOSFET will be turned off immediately, when the power switch voltage exceeds the OVP threshold level. The SD6271's OVP threshold is 27V.

#### **Over Temperature Protection (OTP)**

SD6271 will turn off the power MOSFET automatically when the internal junction temperature is over 150°C. The power MOSFET wake up when the junction temperature drops 30°C under the OTP threshold temperature.

#### **Output Disconnect**

When power on and the EN pin will be pulled high. The SD6271 start up and operates. The external PMOS is turned on and current through it for output loading. While output loading is increase, output voltage is drop. When the FB pin voltage is under 0.3V, the EN pin sinks 20µA current, the external PMOS will be turn off. The output short condition will be disconnected.

## **Application Information**

#### **Inductor Selection**

Inductance value is decided based on different condition. 4.7 to 22µH inductor value is recommended for general application circuit. There are three important inductor specifications, DC resistance, saturation current and core loss. Low DC resistance has better power efficiency. Also, it avoid inductor saturation which will cause circuit system unstable and lower core loss at 1 MHz.

#### **Capacitor Selection**

The output capacitor is required to maintain the DC voltage. Low ESR capacitors are preferred to reduce the output voltage ripple. Ceramic capacitor of X5R and X7R are recommended, which have low equivalent series resistance (ESR) and wider operation temperature range.

#### **Diode Selection**

Schottky diodes with fast recovery times and low forward voltages are recommended. Ensure the diode average and peak current rating exceed the average output current and peak inductor current. In addition, the diode's reverse breakdown voltage must exceed the output voltage.

#### **Output Voltage Programming**

The output voltage is set by a resistive voltage divider from the output voltage to FB. The output voltage is:

$$V_{OUT} = 0.6V \left(1 + \frac{R1}{R2}\right)$$

#### **Layout Considerations**

- 1. The power traces, consisting of the GND trace, the LX trace and the V<sub>CC</sub> trace should be kept short, direct and wide.
- 2. LX \ L and D switching node, wide and short trace to reduce EMI.
- 3. Place C<sub>IN</sub> near V<sub>CC</sub> pin as closely as possible to maintain input voltage steady and filter out the pulsing input current.
- 4. The resistive divider R1and R2 must be connected to FB pin directly as closely as possible.
- 5. FB is a sensitive node. Please keep it away from switching node, LX.
- 6. The GND of the IC,  $C_{IN}$  and  $C_{OUT}$  should be connected close together directly to a ground plane.

# **Typical Application**







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# Package Outline

SOT23-6L



Unit: mm

Symbols	Min. (mm)	Max. (mm)		
A	1.050	1.450		
A1	0.050	0.150		
A2	0.900	1.300		
b	0.300	0.500		
С	0.080	0.220		
D	2.900	BSC		
E	2.800 BSC			
E1	1.600	DO BSC		
е	0.950	) BSC		
e1	1.900 BSC			
L	0.300	0.600		
L1	0.600	) REF		
L2	0.250 BSC			
θ°	0°	8°		
θ1°	3°	7°		
θ2°	6°	15°		

#### Note:

- 1. Package dimensions are in compliance with JEDEC outline: MO-178 AB.
- 2. Dimension "D" does not include molding flash, protrusions or gate burrs.
- 3. Dimension "E1" does not include inter-lead flash or protrusions.